**GD010** 

## FEATURES

- Operating Frequency Range: DC to 8.0GHz
- Operating Drain Voltage: +50V
- Maximum Output Power (PSAT): 15.0W
- Maximum Drain Efficiency: 68%
- Efficiency-Tuned P3dB Gain: 17.8dB
- Bare die shipped in Gel-Pak containers

## DESCRIPTION

The GD010 is a 15W (P3dB) unmatched discrete GaN-on-SiC HEMT which operates from DC to 8.0GHz on a 50V supply rail. The wide bandwidth of the GD010 makes it suitable for a variety of applications including cellular infrastructure, radar, communications, and test instrumentation, and can support both CW and pulsed mode of operations.

Bare die are shipped in Gel-Pak containers for safe transport and storage.

## TYPICAL PERFORMANCE: POWER TUNED, T<sub>A</sub> = 25°C

	3.6 GHz	Units
Gain	16.5	dB
Saturated Output Power	15	W
Drain Efficiency	60	%

 $V_D = 50V, I_{DQ} = 15mA$ 

## TYPICAL PERFORMANCE: EFFICIENCY TUNED, T<sub>A</sub> = 25°C

	3.6 GHz	Units
Gain	17.8	dB
Saturated Output Power	11	W
Drain Efficiency	68	%

 $V_D = 50V, I_{DQ} = 15mA$ 



0.90 x 0.75 mm Die



## 50V, DC - 8.0GHZ, 10W GAN HEMT



## GD010

# 50V, DC - 8.0GHZ, 10W GAN HEMT

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Units
>150	$BV_{DG}(V)$
-8 to +2	V <sub>GS</sub> (V)
55	V (V)
+225	(°C)
-65 to +150	(°C)
	Rating   >150   -8 to +2   55   +225   -65 to +150

## **BLOCK DIAGRAM (units in microns)**



## **ELECTRICAL SPECIFICATIONS:** T<sub>A</sub> = 25°C

Parameter	Min.	Тур.	Max.	Units	Notes
Frequency Range	DC		8000	MHz	
DC Characteristics					
Drain Source Breakdown Voltag	e	150		V <sub>DS</sub> (V)	
Drain Source Leakage Current		0.16		I <sub>DS</sub> (mA)	
Gate Threshold Voltage		-3 to -1.3		V <sub>GS</sub> (V)	
Operating Conditions					
Gate Voltage		-2.5		V <sub>G</sub> (V)	
Drain Voltage		50		V <sub>D</sub> (V)	
Quiescent Drain Current		15		I <sub>DQ</sub> (mA)	
Thermal Characteristics					
Thermal Resistance		TBD		(°C/W)	